

Product End-of-Life Disassembly Instructions

Product Category: Networking Equipment

Marketing Name / Model

[List multiple models if applicable.]

HPE 12900E 24p 10G/2p 40G HB 59xx Mod (JH953A)

HPE 12900E 24p 10G/4p 100G HD 59xx Mod (JH954A)

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HPE products to remove components and materials requiring selective treatment, as defined by EU directive 2012/19/EC, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

| Item Description | Notes | Quantity of items included in product |
|--|---|---------------------------------------|
| Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA) | With a surface greater than 10 sqcm | 3 |
| Batteries | All types including standard alkaline and lithium coin or button style batteries | 0 |
| Mercury-containing components | For example, mercury in lamps, display backlights, scanner lamps, switches, batteries | 0 |
| Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm | Includes background illuminated displays with gas discharge lamps | 0 |
| Cathode Ray Tubes (CRT) | | 0 |
| Capacitors / condensers (Containing PCB/PCT) | | 0 |
| Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height | | 0 |
| External electrical cables and cords | | 0 |
| Gas Discharge Lamps | | 0 |
| Plastics containing Brominated Flame Retardants weighing > 25 grams (not including PCBs or PCAs already listed as a separate item above) | | 0 |
| Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner | Include the cartridges, print heads, tubes, vent chambers, and service stations. | 0 |
| Components and waste containing asbestos | | 0 |
| Components, parts and materials containing refractory ceramic fibers | | 0 |

| Item Description | Notes | Quantity of items included in product |
|---|-------|---------------------------------------|
| Components, parts and materials containing radioactive substances | | 0 |

2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

| Tool Description | Tool Size (if applicable) |
|------------------|---------------------------|
| Screw driver | 2# |
| Socket spanner | M3 |
| | |
| | |
| | |

3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Remover the blank panel 4 than Unscrew the screws on part 1 and part 2, and then remove part 1 and part 2;
2. Remove the film 2-2 and 2-3, than remove foam 2-1 on part 2;
3. Unscrew the screws on pcb 5 and pcb 7, and then remove pcb 5 and pcb 7;
4. Unscrew the screws on heatsink 5-1, and then remove heatsink 5-1 from pcb 5;
5. Unscrew the screws on heatsink 7-1, and then remove heatsink 7-1 from pcb 7;
6. Unscrew the screws on PCB 6, and then remove PCB 6;
7. Unscrew the screws on part 6-1, and then remove part 6-1;
8. Unscrew the screws on heatsink 6-2, and then remove heatsink 6-2;

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

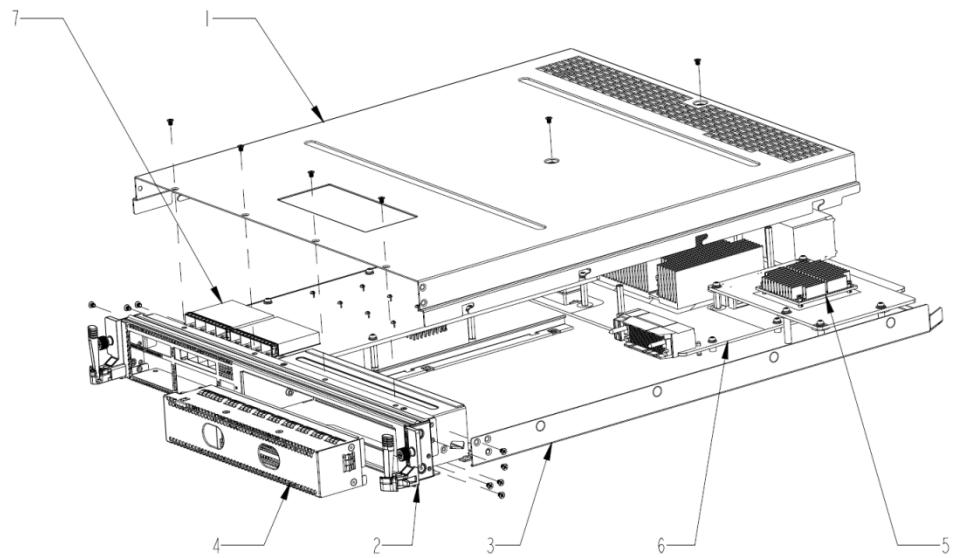


Figure 1 Treatments to the product

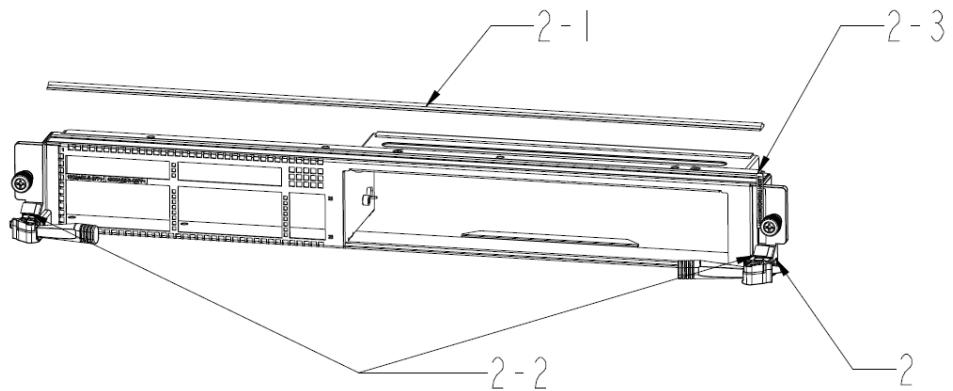


Figure 2 Treatments to the product

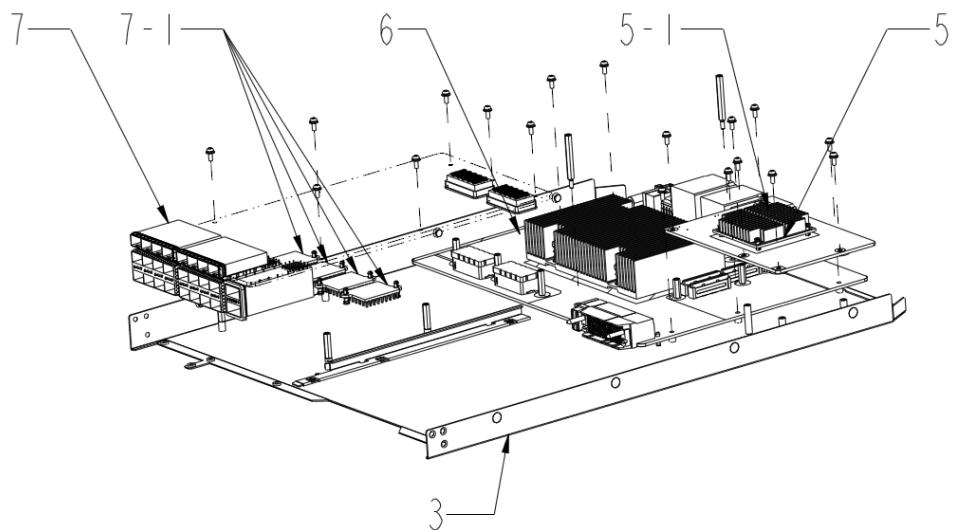


Figure 3 Treatments to the product

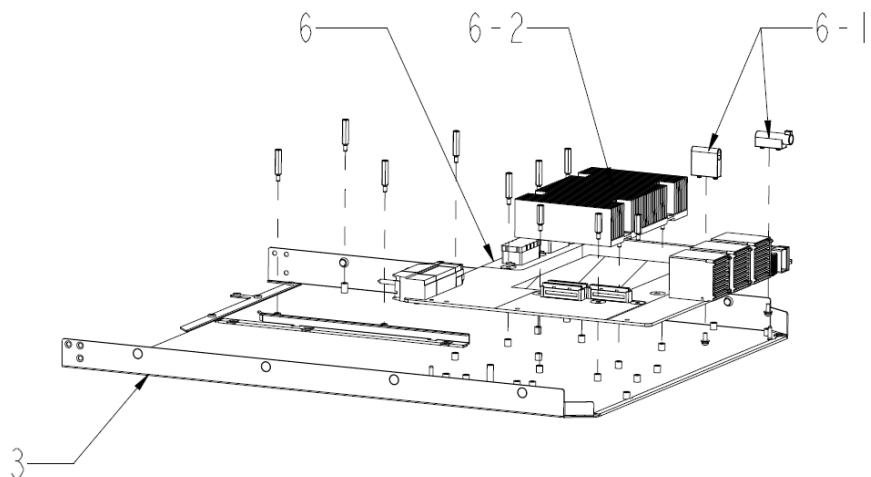


Figure 4 Treatments to the product